

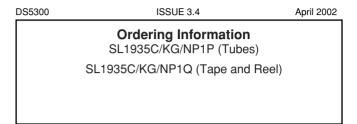
Single Chip Synthesized Zero IF Tuner

Features

- Single chip synthesised tuner solution for quadrature down conversion, L-band to Zero IF.
- DVB compliant, operating dynamic range -70 to -20dBm.
- Compatible with DSS and DVB variable symbol rate applications.
- Selectable baseband path, programmable through I²C bus.
- Excellent quadrature balance up to 30MHz baseband
- Excellent immunity to spurious second harmonic (RF and LO) mixing effects.
- · Low oscillator phase noise and reradiation.
- High output referred linearity for low distortion and multi channel application.
- Integral fast mode compliant I²C bus controlled PLL frequency synthesiser, designed for high comparison frequencies and low phase noise performance.
- Buffered crystal output for clocking QPSK demodulator.
- ESD protection (Normal ESD handling procedures should be observed).

Applications

- · Satellite receiver systems.
- · Data communications systems.



Description

The SL1935 is a complete single chip I²C bus controlled Zero IF tuner and operates from 950 to 2150MHz. It includes an on-board low phase noise PLL frequency synthesiser and low noise LNA/AGC. The SL1935 is intended primarily for application in digital satellite Network Interface Modules and performs the complete tuner function.

The device contains all elements necessary, with the exception of local oscillator tuning network and crystal reference, to produce a high performance I(n-phase) & Q(uadrature) downconversion tuner function. Due to the high signal handling design the device does not require any front end tracking filters.

The SL1935 includes selectable baseband signal paths, allowing application with two externally definable filter bandwidths, facilitating application in variable symbol rate and simulcast systems. The SL1935 is optimised to interface with the VP310 (ADC/QPSK/FEC) Satellite Channel Decoder, available from Zarlink Semiconductor and offers a full front end solution.

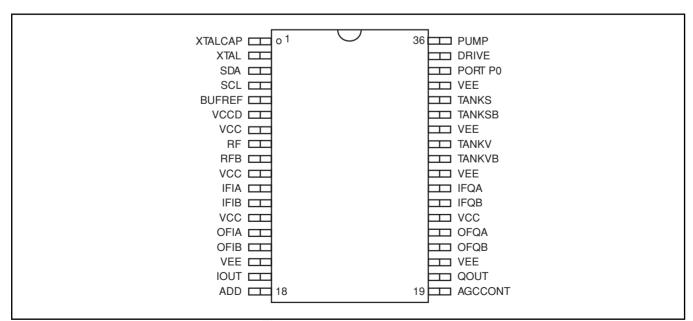


Figure 1. Pin connections

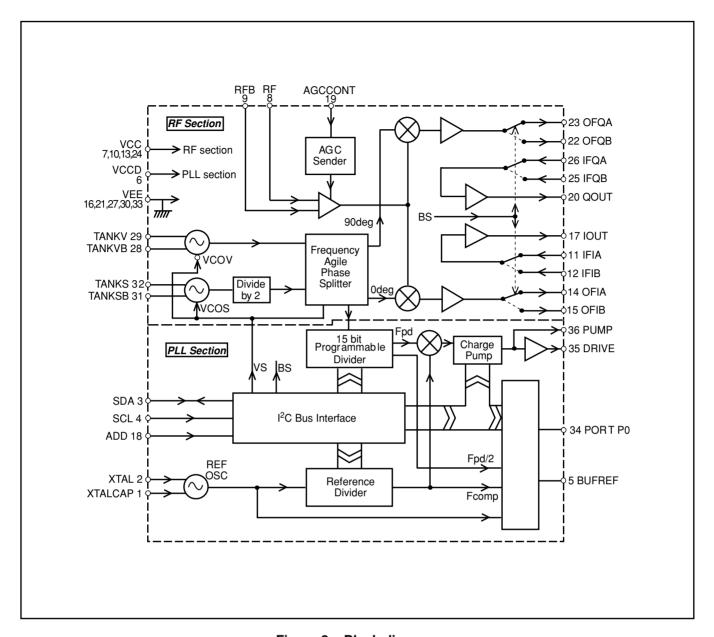


Figure 2. Block diagram

Table 1. Quick Reference Data

| Characteristic | Value | Units |
|---|-------------|--------|
| Operating range | 950 to 2150 | MHz |
| Input dynamic range | -75 to -15 | dBm |
| VSWR with input match | 10 | dB |
| Input NF | | |
| @ -70dBm operating sensitivity | 10 | dB |
| @ -60dBm operating sensitivity | 15 | dB |
| IPIP3 @ -20dBm operating sensitivity | +5 | dBm |
| IPIP2@ -20dBm operating sensitivity | +20 | dBm |
| IPP1dB@ -20dBm operating sensitivity | -5 | dBm |
| Baseband output limit voltage | 2.0 | V |
| Gain match up to 22MHz | 0.2 | dB |
| Phase match up to 22MHz | 0.7 | deg |
| Gain flatness up to 30MHz | 1 | dB |
| Local oscillator phase noise | | |
| SSB at 10kHz offset | -80 | dBc/Hz |
| In band LO reradiation from RF input | <-70 | dBm |
| LO second harmonic interference level at input level of | -55 | dBc |
| -20dBm per carrier | | |
| LNA second harmonic interference level at input level | -35 | dBc |
| of -25dBm per carrier | | |
| PLL maximum comparison frequency | 4 | MHz |
| PLL phase noise at phase detector | -152 | dBc/Hz |

Note: ∞6dB interstage filter loss assumed in external base band paths.

 ∞ dBm assumes 75 Ω characteristic impedance.

Functional Description

General

The SL1935 is a complete wideband direct conversion tuner incorporating an on board frequency synthesiser and LNA/AGC, optimised for application in digital satellite receiver systems. The device offers a highly integrated solution to a satellite tuner function, incorporating an I²C bus interface controller, a low phase noise PLL frequency synthesiser and all tuner analogue functionality. The analogue blocks include the reference oscillator, consisting of two independent oscillators, a phase splitter, RF preamplifier with AGC facility, channel mixers and baseband amplifiers incorporating two selectable baseband paths, allowing for two externally definable bandwidths. In this application two varactor tuned tanks, a reference crystal and baseband filtering components are required to complete the tuner system.

A buffered crystal frequency output is available to clock the QPSK demodulator and powers up in the active state.

The I²C bus interface controls the frequency synthesiser, the local oscillator, the baseband path selection, the buffered reference frequency output and an external switching port.

Figure 2 shows the device block diagram and pin allocations are shown in Figure 1.

Quadrature Downconverter Section

In normal application the tuner IF frequency of typically 950 to 2150MHz is fed direct to the SL1935 RF input through an appropriate impedance match (Fig.16) and LNB switching. The input stage is optimised for both NF and signal handling.

The signal handling of the front end is designed to offer immunity to input composite overload without the requirement of a tracking filter. RF input impedance is shown in Fig.3.

The RF input amplifier feeds an AGC stage and provides system gain control. The system AGC gain range will guarantee an operating dynamic range of -70 to -20dBm. The AGC is controlled by the AGC sender and is optimised for S/N and S/I performance across the full dynamic range. Details of the AGC characteristics, variations in IIP3, IIP2, P1dB and NF are illustrated in Figs.4, 5, 6, 7, and 8 respectively.

The required I and Q local oscillator frequencies for quadrature downconversion are generated by the onboard reference oscillators designated 'VCOS' and 'VCOV'. VCOS operates nominally from 1900 to 3000MHz and is then divided by two to provide 950 to 1500MHz. VCOV operates nominally from 1400 to 2200MHz. Only the oscillator selected via bit VS in the I²C data transmission is powered.

Quadrature Downconverter Section - continued

The oscillators share a common varactor line drive and both require an external varactor tuned resonator optimised for low phase noise performance. The recommended application circuit for the local oscillators is detailed in Fig.9 and the typical phase noise performance is detailed in Fig.10. The local oscillator frequency is coupled internally to the PLL frequency synthesiser programmable divider input.

The mixer outputs are coupled to the baseband buffer amplifiers, providing for one of two selectable baseband outputs in each channel. The required output is selected by bit BS in the I²C bus transmission (Table 6). These outputs are fed off chip via ports 'OPIA' and 'OPIB' ('OPQA' and 'OPQB'), then back on chip through ports 'IPIA' and 'IPIB' ('IPQA' and 'IPQB'), allowing for the insertion of two independent user definable filter bandwidths. Each output provides a low impedance drive (Fig.11) and each input provides a high impedance load. An example filter for 30MS/s is detailed in Fig.13. Both path gains are nominally equal. NB 6dB insertion loss is assumed in each channel, however a different pot down ratio may be applied.

Each baseband path is then multiplexed to the final baseband amplifier stage, providing further gain and a low impedance output drive. The nominal output load test condition is detailed in Fig.14.

PLL Frequency Synthesiser Section

The PLL frequency synthesiser section contains all the elements necessary, with the exception of a reference frequency source and a loop filter to control the selected oscillator to produce a complete PLL frequency synthesised source. The device, produced using high speed logic, allows for operation with a high comparison frequency and enables the generation of a loop with excellent phase noise performance.

The LO signal from the selected oscillator drives from the phase splitter into an internal preamplifier, providing gain and reverse isolation from the divider signals. The output of the preamplifier interfaces directly with the 15-bit fully programmable divider. The programmable divider has MN+A architecture, the dual modulus prescaler is 16/17, the A counter is 4-bits and the M counter is 11-bits.

The output of the programmable divider is fed to the phase comparator and compared in both phase and frequency domains to the comparison frequency. This frequency is derived from either the on board crystal controlled oscillator or from an external reference source. In both cases the reference frequency is divided down to the comparison frequency by the reference divider, programmable into 1 of 29 ratios and detailed in Table 3. The typical application for the crystal oscillator is shown in Fig.15.

The output of the phase detector feeds a charge pump and a loop amplifier. When used with an external loop filter and a high voltage transistor it integrates the current pulses into the varactor line voltage used to control the selected oscillator.

The programmable divider output Fpd divided by two and the reference divider output Fcomp are switched to port P0 by programming the device into test mode. Test modes are detailed in Table 4.

The crystal reference frequency can be switched to the BUFREF output by bit RE as detailed in Table 7.

Programming

The SL1935 is controlled by an I²C data bus and is compatible with both standard and fast mode formats. Data and Clock are fed on the SDA and SCL lines respectively as defined by the I2C bus format. The device can either accept data (write mode) or send data (read mode). The LSB of the address byte (R/W) sets the device into write mode if it is low and read mode if it is high. Tables 9a and 9b detail the format of the data. The SL1935 may be programmed to respond to several addresses and enables the use of more than one device in an I²C bus system. Table 9c details the how the address is selected by applying a voltage to the 'ADD' input. When the device receives a valid address byte, it pulls the SDA line low during the acknowledge period and during following acknowledge periods after further data bytes are received. When the device is programmed into read mode, the controller accepting the data must pull the SDA line low during all status byte acknowledge periods to read another status byte. If the controller fails to pull the SDA line low during this period, the device generates an internal 'STOP' condition which inhibits further reading.

Write mode

Bytes 2 and 3 contain frequency information bits 2^{14} to 2^{0} inclusive (Table 9). Byte 4 controls the synthesiser reference divider ratio (Table 3) and the charge pump setting (Table 5). Byte 5 controls test modes (Table 4), baseband filter path select BS (Table 6), local oscillator select VS (Table 8), buffered crystal reference output select RE (Table 7) and the output port P0.

After reception and acknowledgment of a correct address (byte 1), the first bit of the following byte determines whether the byte is interpreted as byte 2 or 4, a logic '0' indicates byte 2 and a logic '1' indicates byte 4. Having interpreted this byte as either byte 2 or 4, the following byte will be interpreted as byte 3 or 5 respectively. After receiving two complete data bytes, additional data bytes may be entered and byte interpretation follows the same procedure without readdressing the device. The procedure continues until a 'STOP' condition is received.

The STOP condition can be generated after any data byte, if however it occurs during a byte transmission, the previous byte data is retained. To facilitate smooth fine tuning, the frequency data bytes are only accepted by the device after all 15 bits of frequency data have been received, or after the generation of a STOP condition.

Read mode

When the device is in read mode, the status byte read from the device takes the form shown in Table 9b.

Bit 1 (POR) is the power-on reset indicator, and this is set to a logic '1' if the Vccd supply to the device has dropped below 3V (at 25°C),e.g. when the device is initially turned ON. The POR is reset to '0' when the read sequence is terminated by a STOP command. When POR is set high this indicates that the programmed information may have been corrupted and the device reset to the power up condition.

Bit 2 (FL) indicates whether the synthesiser is phase locked, a logic '1' is present if the device is locked, and a logic '0' if the device is unlocked.

Table 2. Programmable Features

| Programmable features | Function |
|--|---|
| Synthesiser programmable divider | Function as described above |
| Reference programmable divider | Function as described above. |
| Baseband filter path select | Function as described above. |
| Local oscillator select | Function as described above. |
| Charge pump current | The charge pump current can be programmed by bits C1 & C0 (Table 5). |
| Test mode | The test modes are defined by bits T2 - T0 as described in Table 4. |
| General purpose port, P0 | The general purpose port can be programmed by bit P0; |
| | Logic '1' = on |
| | Logic '0' = off (high impedance) |
| Buffered crystal reference output, BUFREF | The buffered crystal reference frequency can be switched to the BUFREF output by bit RE as described in Table 7. The BUFREF output defaults to the 'ON' condition at device power up. |

The typical key performance data at Vcc = 5V and +25°C ambient are detailed in Table 1.

Table 3. Reference division ratios

| R4 | R3 | R2 | R1 | R0 | Ratio |
|---|---|--|--------------------------|------------------------------|---|
| 000000000000011111111111111111111111111 | 000000011111100000001111111111111111111 | 0 0 0 0 1 1 1 1 0 0 0 0 1 1 1 1 1 0 0 0 0 1 1 1 | 001100110011001100110011 | 0101010101010101010101010101 | 2 4 8 16 32 64 128 256 110 20 40 80 160 320 11egal state 6 12 24 48 96 192 384 11egal state 7 14 28 56 112 224 448 |

Table 4. Test modes

| T2 | T1 | T0 | Test mode description |
|----|----|----|--|
| 0 | 0 | 0 | Normal operation |
| 0 | 0 | 1 | Charge pump sink* (status byte FL set to logic '0') |
| 0 | 1 | 0 | Charge pump source* (status byte FL set to logic '0') |
| 0 | 1 | 1 | Charge pump disabled* (status byte FL set to logic '1') |
| 1 | 0 | 0 | Normal operation and port P0 = Fpd/2 |
| 1 | 0 | 1 | Charge pump sink* (status byte FL set to logic '0'. Port P0 = Fcomp) |
| 1 | 1 | 0 | Charge pump source* (status byte FL set to logic '0'. Port P0 = Fcomp) |
| 1 | 1 | 1 | Charge pump disabled* (status byte FL set to logic '1'. Port P0 = Fcomp) |

Note: * Clocks need to be present on crystal and RF inputs to enable charge pump test modes and to toggle status byte bit FL.

Table 5. Charge pump current

| C1 | C0 | Cı | urrent in µ | ιA |
|----|----|--------|-------------|--------|
| Ci | O | min | typ | max |
| 0 | 0 | +-116 | +-155 | +-194 |
| 0 | 1 | +-247 | +-330 | +-412 |
| 1 | 0 | +-517 | +-690 | +-862 |
| 1 | 1 | +-1087 | +-1450 | +-1812 |

Table 6. Baseband path select

| | | | . | | | | |
|---|----|------------------------|--------------------|------------------------|--------------------|--|--|
| I | | | Path Se | elected | | | |
| ı | BS | I Cha | nnel | Q Channel | | | |
| l | | Filter drive output | Baseband amp input | Filter drive output | Baseband amp input | | |
| I | 0 | OFIB | IFIB | OFQB | IFQB | | |
| ı | 1 | OFIA | IFIA | OFQA | IFQA | | |

Table 7. Buffered crystal reference output select

| RE | BUFREF output |
|----|--------------------------|
| 0 | Disabled, high impedance |
| 1 | Enabled |

Table 8. Local oscillator select

| VS | Local oscillator selected |
|----|---------------------------|
| 0 | VCOV |
| 1 | vcos |

Table 9a. Write data format (MSB is transmitted first)

| | MSB | | | | | | | LSB | | |
|----------------------|----------------|-----------------|-----------------|-----------------|-----------------|-----------------|----------------|----------------|---|--------|
| Address | 1 | 1 | 0 | 0 | 0 | MA1 | MA0 | 0 | Α | Byte 1 |
| Programmable divider | 0 | 2 ¹⁴ | 2 ¹³ | 2 ¹² | 2 ¹¹ | 2 ¹⁰ | 2 ⁹ | 2 ⁸ | Α | Byte 2 |
| Programmable divider | 2 ⁷ | 2 ⁶ | 2 ⁵ | 2 ⁴ | 2 ³ | 2 ² | 2 ¹ | 2 ⁰ | Α | Byte 3 |
| Control data | 1 | C1 | C0 | R4 | R3 | R2 | R1 | R0 | Α | Byte 4 |
| Control data | T2 | T1 | T0 | VS | BS | 0 | RE | P0 | Α | Byte 5 |

Table 9b. Read data format (MSB is transmitted first)

| | MSB | | | | | | | LSB | | |
|-------------|-----|----|---|---|---|-----|-----|-----|---|--------|
| Address | 1 | 1 | 0 | 0 | 0 | MA1 | MA0 | 1 | Α | Byte 1 |
| Status Byte | POR | FL | 0 | 0 | 0 | 0 | 0 | 0 | Α | Byte 2 |

Table 9c. Address selection

| MA1 | MA0 | Address input voltage level |
|-----|-----|-----------------------------|
| 0 | 0 | 0 - 0.1 Vcc |
| 0 | 1 | Open circuit |
| 1 | 0 | 0.4 Vcc - 0.6 Vcc* |
| 1 | 1 | 0.9 Vcc - Vcc |

Note: * Programmed by connecting a $30k\Omega$ resistor between pin and Vcc

Key to Tables 9a to 9c

| A | Acknowledge bit |
|-----------------------------------|--|
| | Variable address bits (Table 9c) |
| 2 ¹⁴ to 2 ⁰ | Programmable division ratio control bits |
| | Charge pump current select (Table 5) |
| R4 to R0 | Reference division ratio select (Table 3) |
| T2 to T0 | Test modes control bits (Table 4) |
| BS | Baseband path select (Table 6) |
| VS | Local oscillator select (Table 8) |
| RE | Buffered crystal reference output enable (Table 7) |
| P0 | P0 port output state |
| POR | Power on reset indicator |
| FL | Phase lock flag |

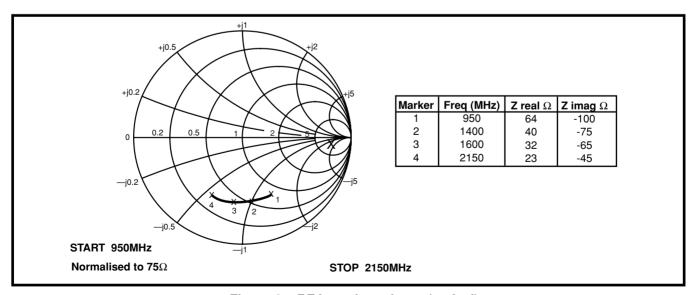


Figure 3. RF input impedance (typical)

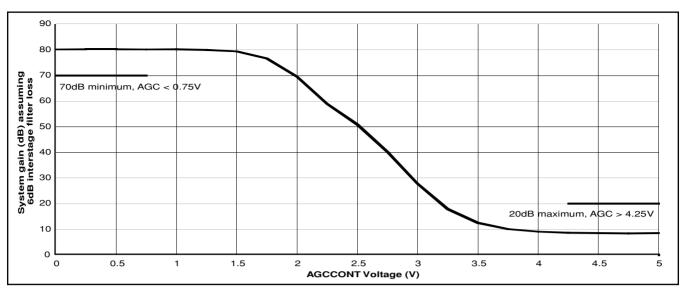


Figure 4. AGC characteristic (typical)

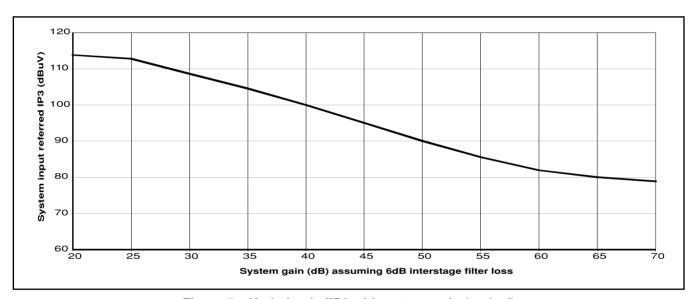


Figure 5. Variation in IIP3 with system gain (typical)

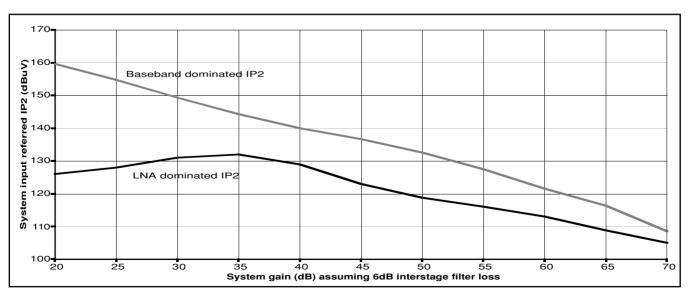


Figure 6. Variation in IIP2 with system gain (typical)

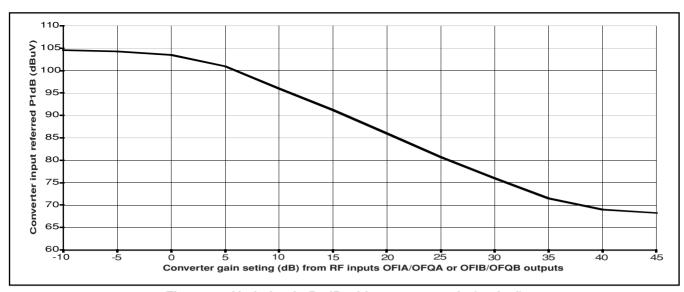


Figure 7. Variation in P1dB with converter gain (typical)

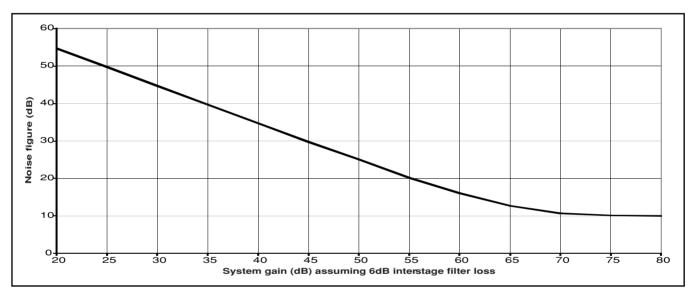


Figure 8. Variation in NF with system gain (typical)

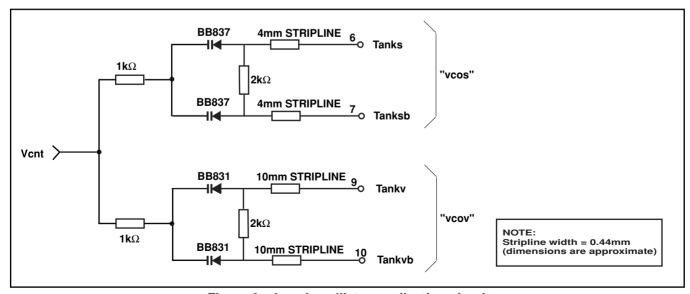


Figure 9. Local oscillator application circuit

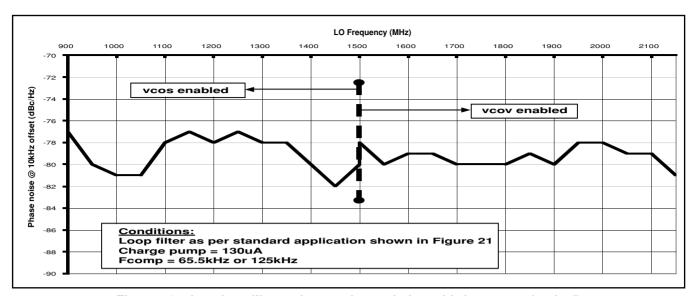


Figure 10. Local oscillator phase noise variation with frequency (typical)

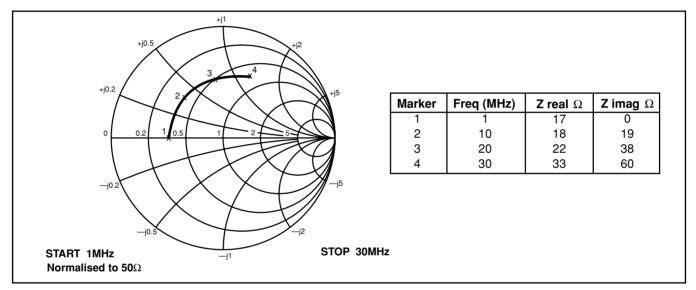


Figure 11. Converter output impedance; OFIA, OFIB, OFQA, OFQB (typical)

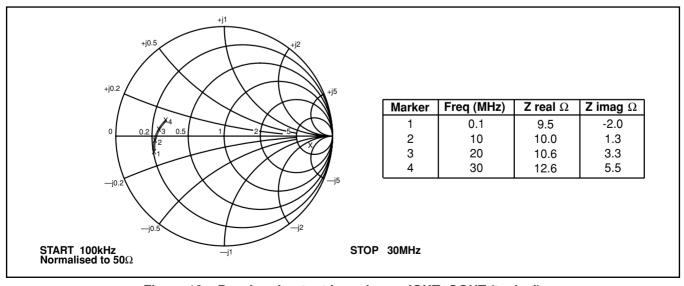


Figure 12. Baseband output impedance; IOUT, QOUT (typical)

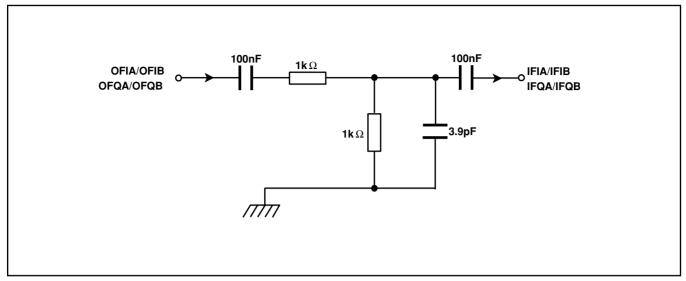


Figure 13. Example baseband interstage filter for 30MS/s

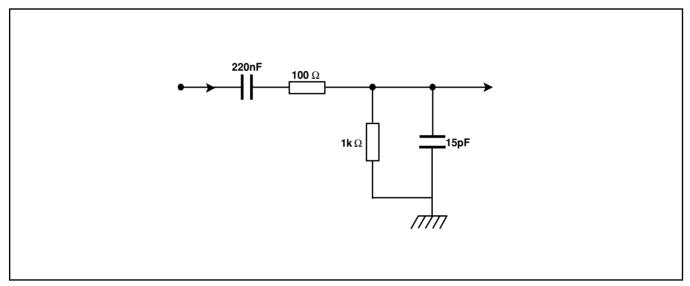


Figure 14. Nominal baseband output load test condition

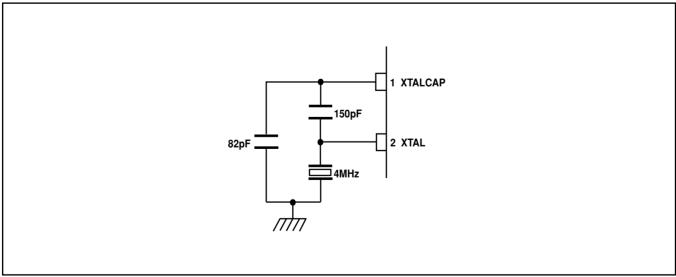


Figure 15. Crystal oscillator application (typical)

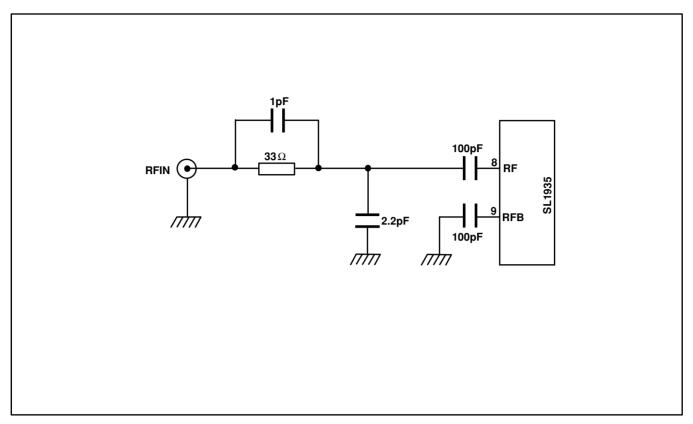


Figure 16. Input matching network

Table 10. Electrical Characteristics

Test conditions (unless otherwise stated); Tamb = -20° to $+80^{\circ}$ C, Vee= 0V, Vcc =Vccd = 5V+-5%. These characteristics are guaranteed by either production test or design. They apply within the specified ambient temperature and supply voltage unless otherwise stated.

| Characteristic | Pin | | | Units | Conditions | |
|------------------------------------|--------|-----|-----|-------|-------------|---------------------------------------|
| Cital acteristic | | Min | Тур | Max | | 00.11.11.01.0 |
| Supply current | 6,7,10 | | 130 | 175 | mA | VCCD (PLL) and VCC |
| | 13,24 | | | | l | |
| RF input operating frequency | 8,9 | 950 | | 2150 | MHz | |
| SYSTEM | | | | | | All system specification items should |
| | | | | | | be read in conjunction with Note 2 |
| System noise figure DSB | | | 10 | 12 | dB | At -70dBm operating sensitivity |
| | | | 15 | 17 | dB | At -60dBm operating sensitivity |
| Variation in system NF with gain | | | | -1 | dB/dB | Above -60dBm operating sensitivity, |
| adjust | | | | | | (Fig.7) |
| System input referred IP2 | | 121 | 140 | | dBμV | At -20dBm operating sensitivity, see |
| | | | | | ' | Notes 3 and 4 |
| Variation in system input referred | | | | | | (Fig.6) |
| IP2 with operating sensitivity | | | | | | (* 1910) |
| System input referred IP3 | | 112 | | | dBμV | At -20dBm operating sensitivity, |
| Joseph Market Colonica III C | | | | | J. 2,2 pt 1 | see Note 5 |
| Variation in system input referred | | | | | | (Fig.5) |
| IP3 with operating sensitivity | | | | | | [(i ig.5) |
| In a with operating sensitivity | | | | | | |

Continued

 Table 10. Electrical Characteristics (Continued)

| Characteristic Pin | | Value | | | Units | Conditions | |
|--|-------------------------|----------|---------|---------------|------------------------|---|--|
| Characteristic | PIII | Min | Тур Мах | | Uiilis | Conditions | |
| System dynamic range System gain roll off System gain variation with temperature | | -70 | 3 2 | -20 | dBm dBm dB dB | Note 6 AGCCONT = 0.75V AGCCONT = 4.25V Within RF band 950-2150MHz -20°C to +80°C | |
| System I Q gain match System I Q phase balance System I and Q channel in band ripple | 17,20 17,20 17,20 | -1 -3 | | +1 +3 1 | dB deg dB | Interstage filter (Fig.13) Interstage filter (Fig.13) Interstage filter (Fig.13) | |
| System baseband path gain match | | -1 | | +1 | dB | | |
| LO second harmonic interference level | | | -50 | | dBc | Note 8. | |
| LNA second harmonic interference level | | | -35 | | dBc | Note 9. | |
| Synthesiser and other spurii on I and Q outputs | 17,20 | | | 76 | dBμV | Within 0-100MHz band under all gain settings, RF input set to deliver | |
| In band leakage to RF input | 8,9 | | -60 | | dBm | 108dBμV on output Within RF band 950-2150MHz. Note 11. | |
| CONVERTER Converter input impedance Converter input return loss System input referred P1dB | 8,9 8,9 | 8 102 | 75 | | Ω dB dBμV | With input matching (Fig.16) Converter gain =-5dBm (to OFIA/OPQA, OFIB/OPQB outputs. Fig.7) | |
| Converter output impedance, OFIA, OFIB, OPQA and OPQB. | 14,15 22,23 | | 25 | 50 | Ω | 0.1 to 30MHz (Fig.11) | |
| Converter output leakage to unselected output, OFIA, OFIB, OPQA and OPQB. | | | -26 | | dBc | Relative to selected output | |
| Oscillator VCOS operating range | 31,32 | 1900 | | 3000 | MHz | Giving LO = 950 to 1500MHz (Application as in Fig.9) | |
| Oscillator VCOV operating range Local oscillator SSB phase noise | 28,29 | 1450 | -78 | 2150 | MHz dBc/Hz | (Application as in Fig.9) @10kHz offset, PLL loop bw < 1kHz Application is measured at baseband output frequency of 10MHz (Fig.10). | |
| AGCONT input current | 19 | -150 | | 150 | μΑ | | |
| BASEBAND AMPLIFIERS Baseband input impedance, IFIA, IFIB, IFQA And IFQB. | 11,12 25,26 | | | | | The baseband inputs must be externally ac coupled 0.1- 30MHz bandwidth | |
| Resistance Capacitance | 17,20 | 10 | | 5 -40 | kΩ pF dBc | Relative to selected input. | |
| Baseband amplifier output impedance | 17,20 | | | 20 | Ω | | |
| Baseband output limiting Baseband bandwidth 1dB Baseband output roll-off | 17,20 17,20 | 40 6 | 2.0 | | Vp-p MHz dB/oct | Level at hard clipping (load as Fig.14) (Load as Fig.14) Above 3dB point, no load | |

Continued

Table 10. Electrical Characteristics (Continued)

| Characteristic | Pin | Value | | | Units | Conditions | |
|--|----------|---------|-------------|------------|--------------------------|---|--|
| Characteristic | | Min | Тур | Max | | Containons | |
| SYNTHESISER SDA,SCL Input high voltage | 3,4 | 3 | | 5.5 | V | I ² C 'fast mode' compliant | |
| Input low voltage | | 0 | | 1.5 | V | | |
| Input high current Input low current | | -10 | | 10 | μ Α μ Α | Input voltage = Vcc Input voltage = Vee | |
| Leakage current Hysterysis | | | 0.4 | 10 | μA V | Vcc = Vee = 0V | |
| SDA output voltage | 3 | | | 0.4 0.6 | V V | Isink = 3mA Isink = 6mA | |
| SCL clock rate Charge pump output current | 4 36 | | | 400 | kHz | Vpin36 = 2V. (Table 5) | |
| Charge pump output leakage Charge pump drive output current | 36 35 | 0.5 | +-3 | +-10 | nA mA | Vpin36 = 2V Vpin35 = 0.7V | |
| Crystal frequency Recommended crystal series resistance | 1,2 | 2 10 | | 20 200 | MHz Ω | (Fig.15 for application) 4MHz parallel resonant crystal | |
| External reference input frequency | 2 | 2 | | 20 | MHz | Sinewave coupled via 10nF blocking capacitor | |
| External reference drive level | 2 | 0.2 | | 0.5 | Vpp | Sinewave coupled via 10nF blocking capacitor | |
| Phase detector comparison frequency | | | | 4 | MHz | | |
| Equivalent phase noise at phase detector | | | -152 | | dBc/Hz | SSB within loop bandwidth, all comparison frequencies | |
| Local oscillator programmable divider division ratio | | 240 | | 32767 | | | |
| Reference division ratio Output port P0 | 34 | | | | | (Table 3) (Note 7) | |
| Sink current Leakage current | | 2 | | 10 | mA μA | Vport = 0.7 Vport = Vcc | |
| BUFREF output Output amplitude Output impedance | 5 | 0.25 | 0.35 250 | 0.45 | Vpp Ω | AC coupled. (Note 10.) Enabled by bit RE = 1 and default state on power-up. | |
| Address select Input high curent Input low current | 18 | | | 1 -0.5 | mA mA | (Table 9c) Vin = Vcc Vin = Vee | |

Notes to Table 10

- 1. All power levels are referred to 75Ω , and $0dBm = 109dB\mu V$.
- 2. System specifications refer to total cascaded system of converter/AGC stage and baseband amplifier stagewith nominal 6dB pad as interstage filter and load impedance as detailed in Figure 14.
- 3. Baseband dominated IP2. AGC set for 20dB system gain with two tones for intermodulation test at fc+146and fc+155MHz at 100dBμV generating output intermodulation spur at 9MHz. 30MHz 3dB bandwidthinterstage filter included.
- 4. LNA dominated IP2. AGC set for 20dB system gain with two tones for intermodulation test at fc+146 and2*fc+155 MHz at 100dBμV generating output intermodulation spur at 9MHz. 30MHz 3dB bandwidthinterstage filter included.
- AGC set for 20dB system gain with two tones for intermodulation test at fc+110 and fc+211MHz at 100dBμVgenerating output intermodulation spur at 9MHz. 30MHz 3dB bandwidth interstage filter included.
- 6. Dynamic range assuming termination as detailed in Figure 14, and including 6 dB interstage filter insertion loss, delivering 700mVp-p at baseband outputs (pins 17,20). AGC monotonic from Vee to Vcc (Fig.4).
- 7. Port powers up in high impedance state.
- 8. The level of 2.01GHz downconverted to baseband relative to 1.01GHz with the oscillator tuned to 1GHz, measured with no input pre-filtering.
- 9. The level of second harmonic of 1.01GHz input at –25dBm downconverted to baseband relative to 2.01GHz at–40 dBm with the oscillator tuned to 2GHz, measured with no input pre-filtering.
- 10. If the BUFREF output is not used it should be left open circuit or connected to Vccd, and disabled by settingRE = '0'.
- 11. This parameter is very application dependant. With good RF isolation <-60dBm can be achieved.

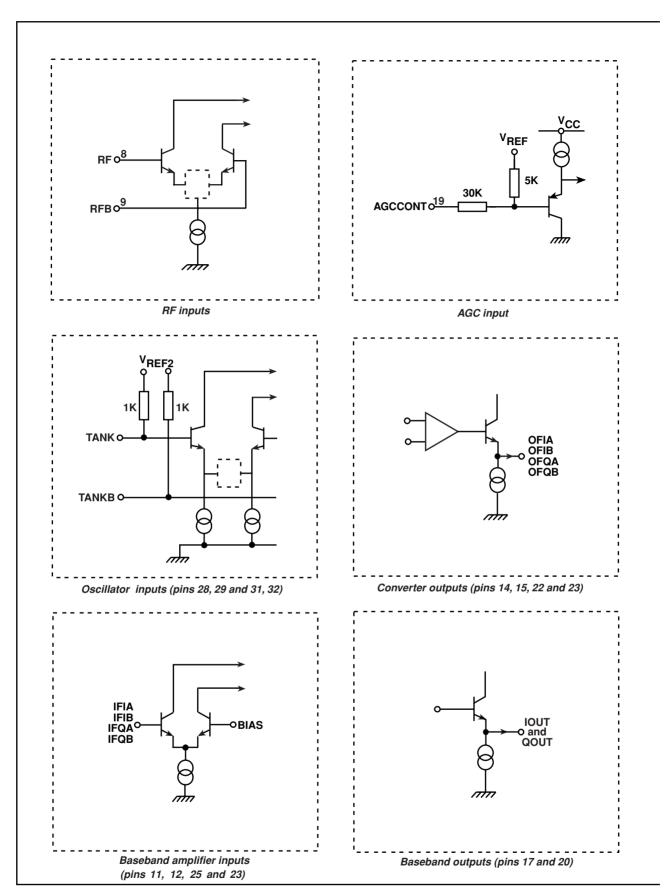


Figure 17. Input and output interface circuits (RF section)

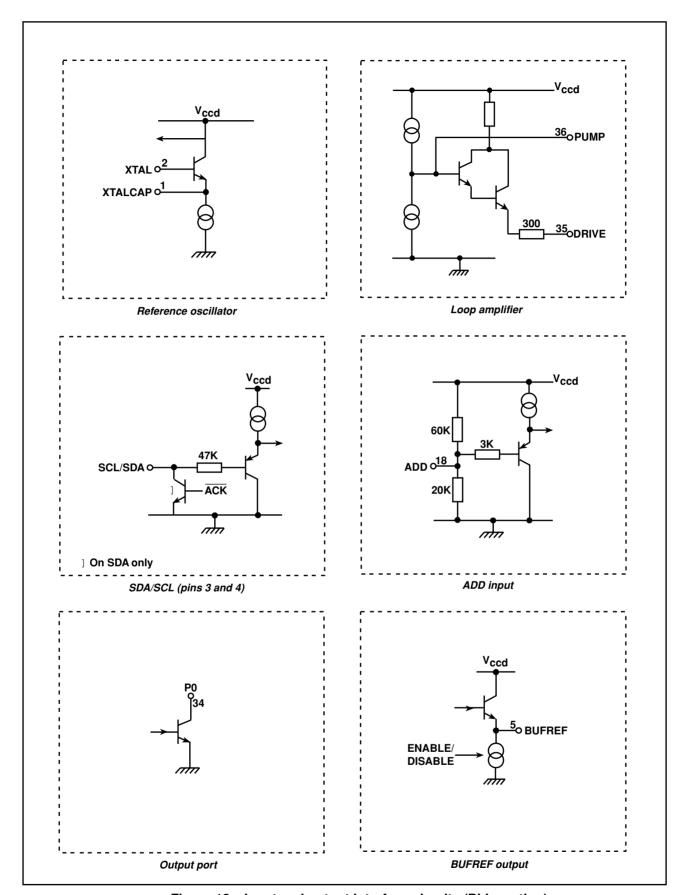


Figure 18. Input and output interface circuits (PLL section)

Table 11. Absolute Maximum Ratings (All voltages referred to Vee at 0V and Vcc = Vccd)

| Characteristic | Min | Max | Units | Conditions |
|-----------------------------|------|---------|-------|------------------------------|
| Supply voltage | -0.3 | 7 | V | |
| SDA, SCL DC offsets | -0.3 | 6 | V | Vcc = Vee to 5.25V |
| All I/O port DC offsets | -0.3 | Vcc+0.3 | V | |
| Port P0 current | | 10 | mA | |
| Storage temperature | -55 | 150 | °C | |
| Junction temperature | | 150 | °C | |
| Package thermal resistance, | | 20 | °C/W | |
| chip to case | | | | |
| Package thermal resistance, | | 77 | °C/W | |
| chip to ambient | | | | |
| Power consumption at 5.25V | | 919 | mW | |
| ESD protection | 3.5 | | kV | Mil-std 883 method 3015 cat1 |

SL1935 Demo Board

The demo board contains an SL1935 I^2C bus controlled Zero IF tuner IC, plus all components necessary to demonstrate operation of the SL1935. The schematic and PCB layout of the board are shown in Figures 19, 20 and 21.

Supplies

The board must be provided with the following supplies:

5V for the synthesiser section (5VD) 5V for the converter and baseband sections (5V) 30V for the varactor line (30V)

The supply connector is a 5 pin 0.1" pin header.

The order of connections is 5V – GND – 30V – GND – 5V.

I²C bus connections

The board is provided with a RJ11 I²C bus connector which feeds directly to the synthesiser. This connects to a standard 4 way cable.

Operating instructions

1. Software.

Use the Zarlink Semiconductor synthesiser software. Pull down the 'Device' menu, then select the 'SL1935'. It is suggested that the charge pump is set to 130uA with a reference divider ratio of 32. These settings give a small loop bandwidth (i.e. 100's Hz), which allows detailed phase noise measurements of the oscillators to be taken if desired.

2. VCO control.

The two VCO's are selected by toggling the oscillator switch below the two oscillators on the main software block diagram. This switch programs bit VS of the I²C data (see Tables 8 and 9a to 9c).

VCOS oscillates at twice the LO frequency (lower band) and is then divided by two to provide the required LO frequency in the range 950MHz to 1500MHz (approximately).

VCOV oscillates at the LO frequency (upper band) in the range 1500MHz to 2150MHz (approximately).

3. Baseband path select.

The SL1935 has two filter paths selected by programming bit BS of the I^2C data (see Tables 6 and 9a to 9c). The value of BS is changed by toggling the switch position to the left of 'Filter A' and 'Filter B' on the main software block diagram.

4. AGC control.

The conversion gain of the SL1935 is set by the voltage applied to the AGCCONT input. On the demo board this is controlled by the potential divider labelled 'AGC ADJ' which varies the AGCCONT input from 0V to Vcc.

CAUTION: Care should be taken to ensure the chip is powered ON if the board is modified to accept an external AGC input voltage. Damage to the device may result if this is not complied with as a result of the IC powering itself up via the AGCCONT input ESD protection diode. It is recommended that a low current limit is set on any external AGC voltage source used.

5. Free running the VCO's.

Select the required VCO as detailed in (2) above. Program an LO frequency which is above the maximum capability of the oscillator. 3GHz is suggested. Under this condition the varactor control voltage is pumped to its maximum value, ie to the top of the band. The oscillator frequency can now be manually tuned by varying the 30V supply.

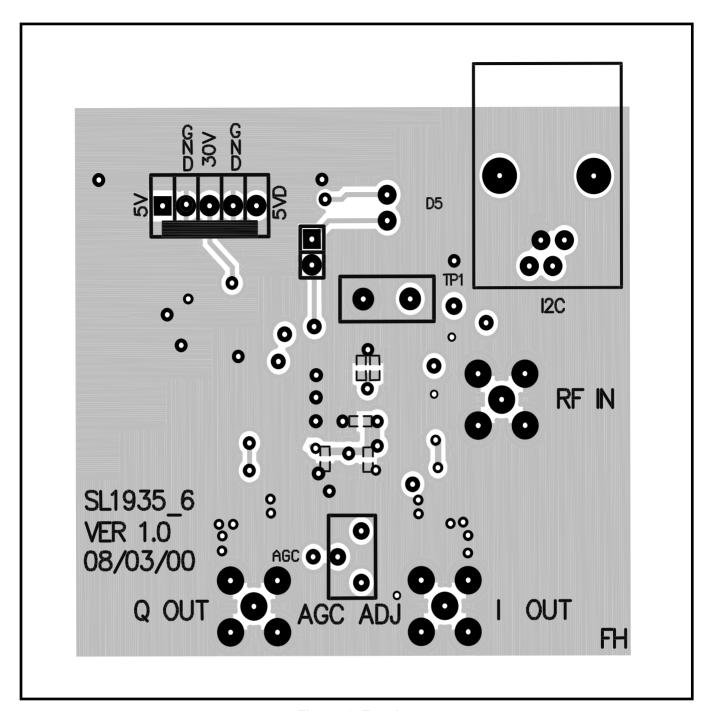


Figure 19. Top view

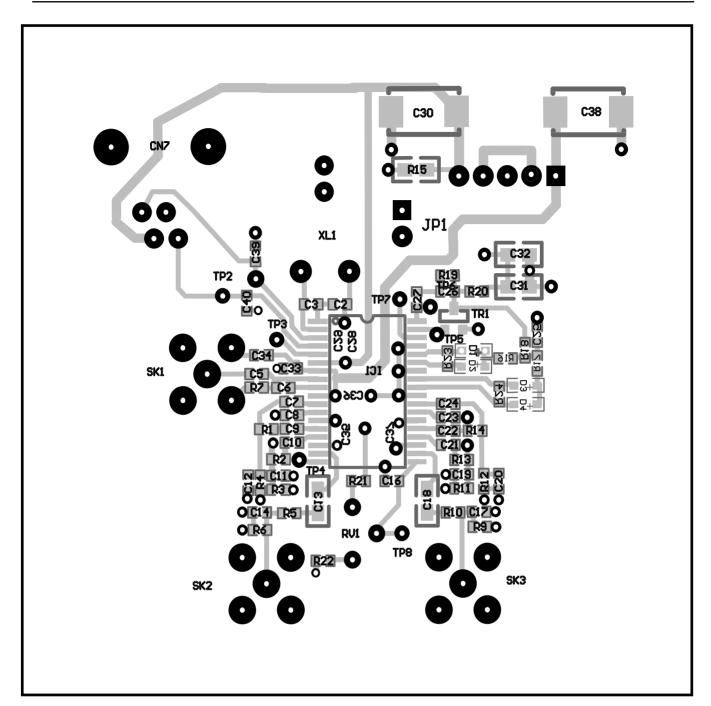


Figure 20. Bottom view

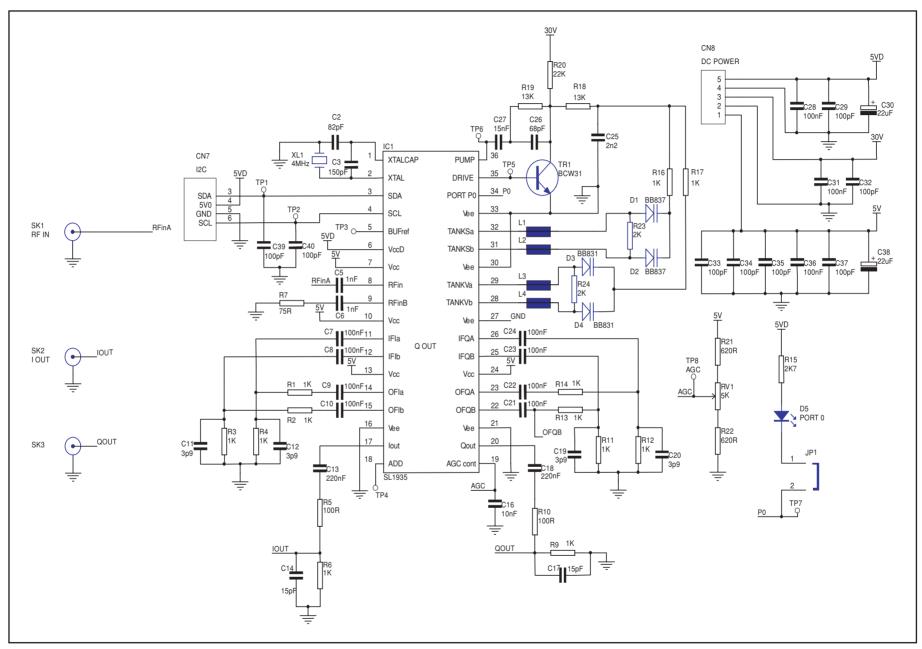
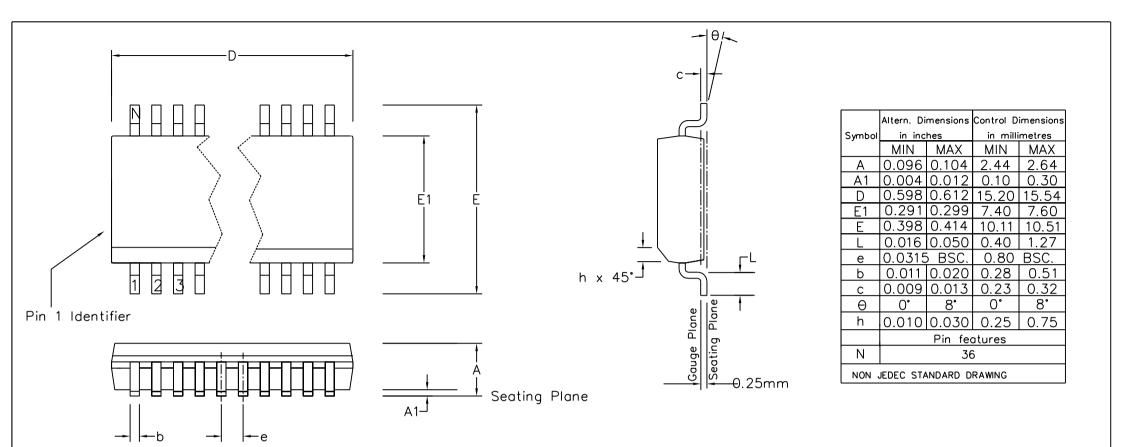


Figure 21.

Purchase of Mitel Semiconductor I²C components conveys a licence under the Phillips I²C Patent rights to use these components in an I²C system,provided that the system conforms to the I²C Standard Specification as defined by Phillips.



Notes:

- 1. Dimensioning and tolerancing per ANSI Y14.5M 1982
- 2. The chamfer on the body is optional. If it is not present, a visual index feature, e.g. a dot, must be located at pin 1 position.
- 3. Controlling dimensions are in millimeters
- 4. D & E1 do not include mould flash or protrusion. But do include mold mismatch.
- 5. Dimension E1 does not include inter-lead flash or protrusion. These shall not exceed 0.010" per side.
- 6. Dimension b does not include dambar protrusion/intrusion. Allowable dambar protrusion shall be 0.13mm total in excess of b dimension.
- 7. Not to Scale

| © Zarlink Semiconductor 2002 All rights reserved. | | | | | | Package Code () () |
|---|---------|--------|---------|-----------------------|------------------------|------------------------------------|
| ISSUE | 1 | 2 | 3 | | Previous package codes | Package Outline for |
| ACN | 6741 | 207728 | 212423 | ZARLINK SEMICONDUCTOR | | 36 lead SSOP (7.5mm Body Width) |
| DATE | 14MAR95 | 5NOV99 | 22Mar02 | SEWICONDUCTOR | | , , , |
| APPRD. | | | | | | GPD00008 |



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